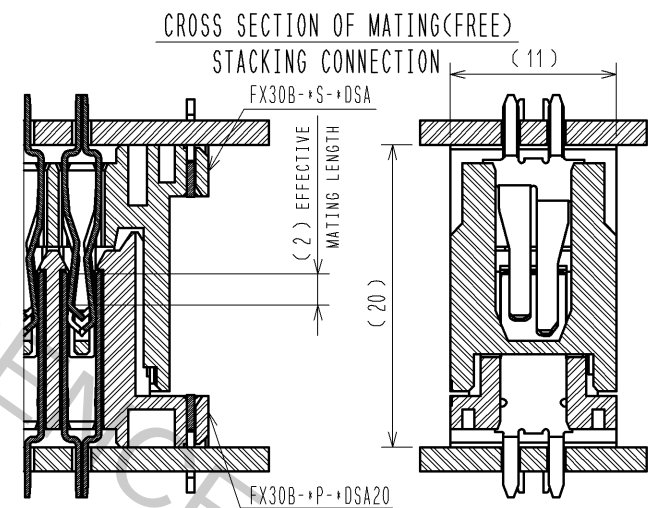
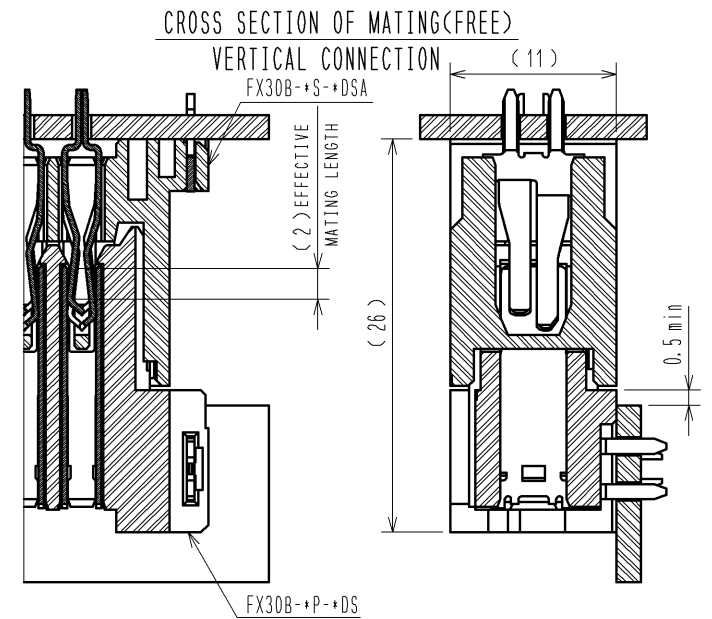
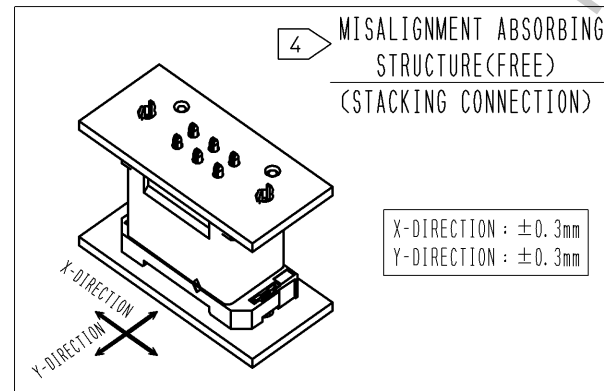
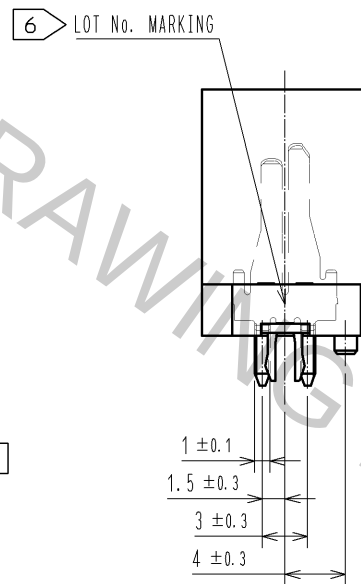
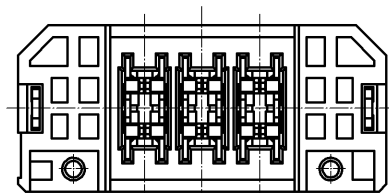
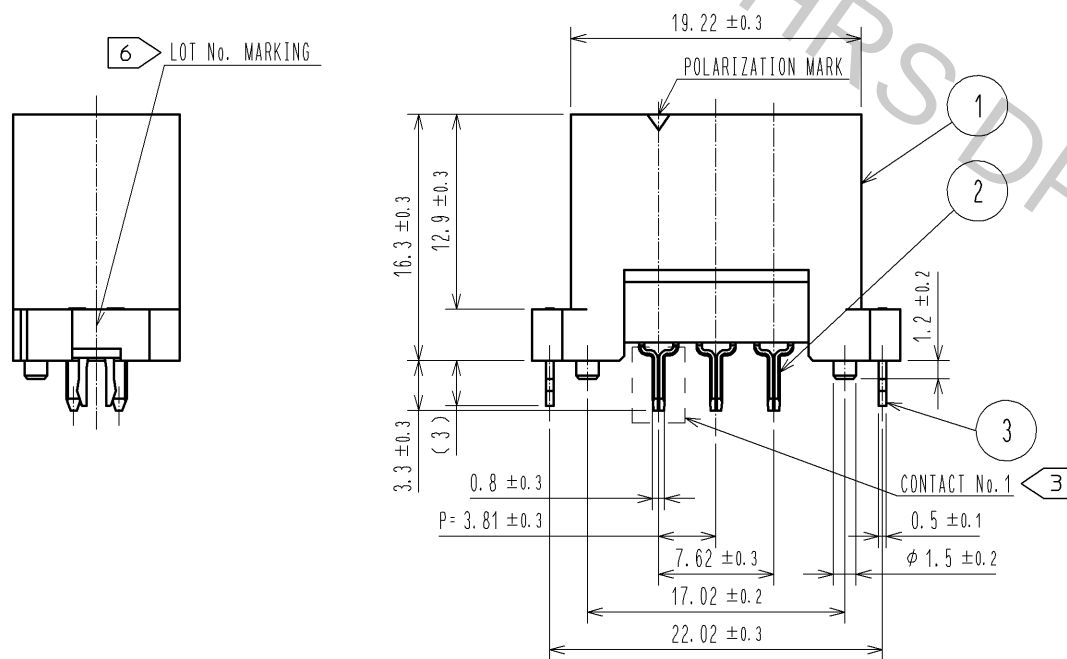
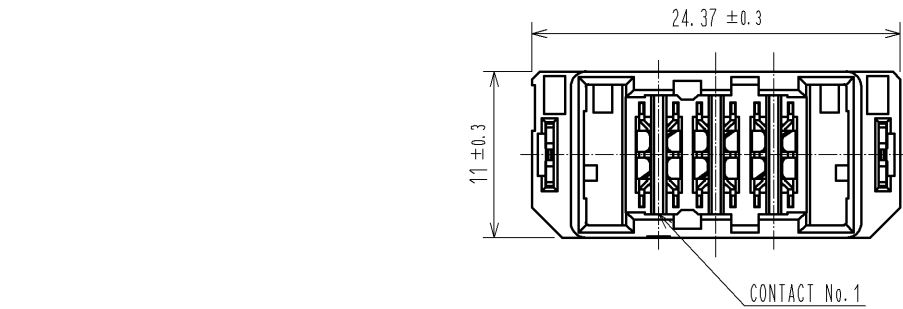
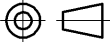




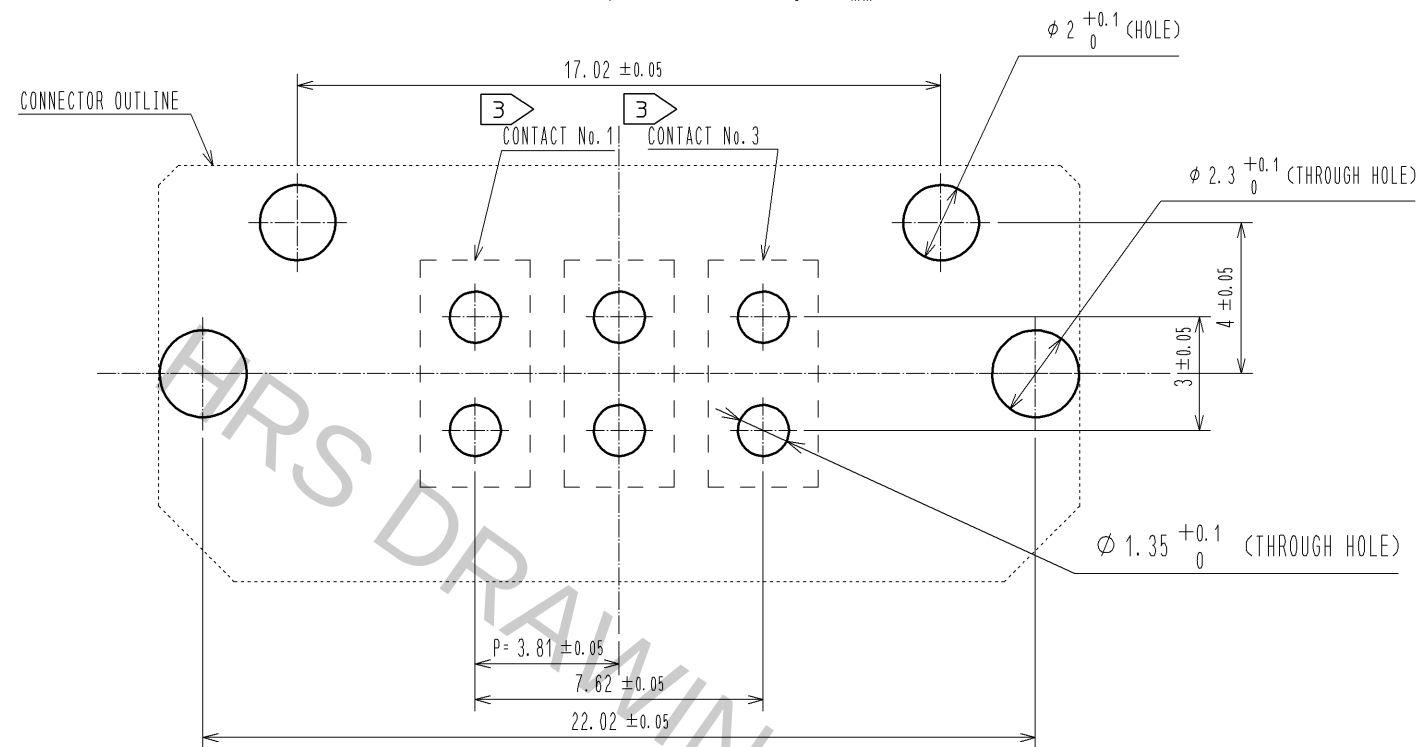
- NOTE
- 1 THIS PRODUCT IS PACKAGED IN TRAY. (42pcs/TRAY)
 - 2 BLEMISH AND HIT MARK CAN BE OCCURED THROUGH OUT THE MANUFACTURING PROCESS WHICH DOESN'T AFFECT QUALITY LEVEL. ALSO, BLACK SPOT COULD BE OBSERVED ON THE SURFACE OF HOUSING.
 - 3 FOR THE CONTACT NO., ADJACENT TWO PAIRS OF LEADS PLACED BACK-TO-BACK (4 LEADS IN TOTAL) COMPOSE ONE LINE.
 - 4 MISALIGNMENT ABSORBING RANGE: ±0.3mm max.
 - 5 THE DIMENSION IN PARENTHESES ARE FOR REFERENCES.
 - 6 LOT NO. IS INDICATED AT EITHER ONE OF THE POSITION AS SHOWN.

2	COPPER ALLOY	CONTACT AREA:GOLD-PLATING 0.1 μm		4	POLYSTYRENE				
		LEAD AREA:TIN-PLATING 1.0 μm							
		UNDER PLATING:NICKEL 1.0 μm				TIN-PLATING 3.0 μm			
1	POLYAMIDE	BLACK UL94V-0		3	PHOSPHOR BRONZE	UNDER PLATING:NICKEL 1.0 μm			
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS			
UNITS mm			SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		13.03.13		DRAWING NO. EDC3-347273-00			
		CHECED : KI. HIROKAWA		13.03.12		PART NO. FX30B-3S-3. 81DSA			
		DESIGNED : DK. AIMOTO		13.03.11		CODE NO. CL570-3501-4-00			
		DRAWN : DK. AIMOTO		13.03.11		 1/2			

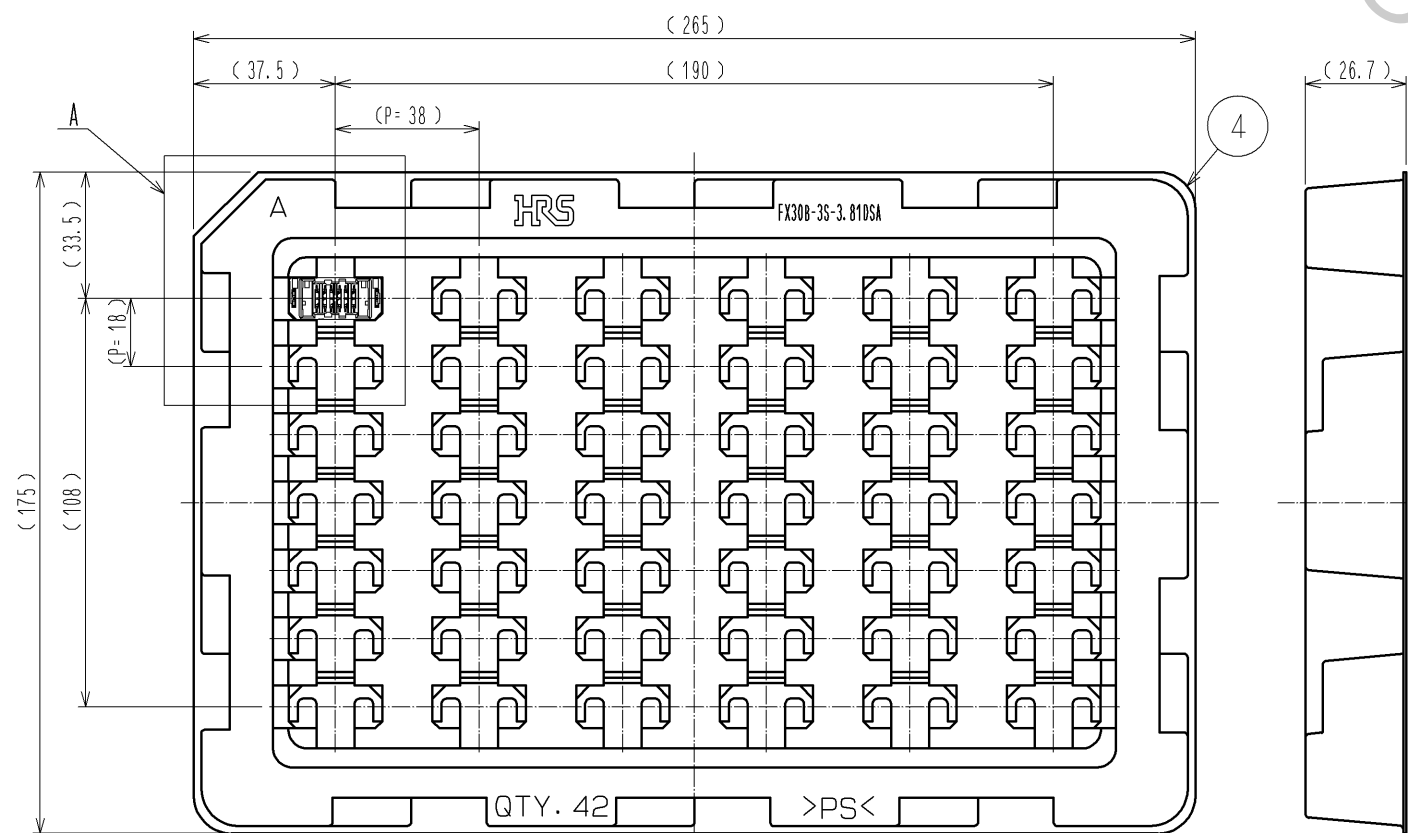
A
B
C
D
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A
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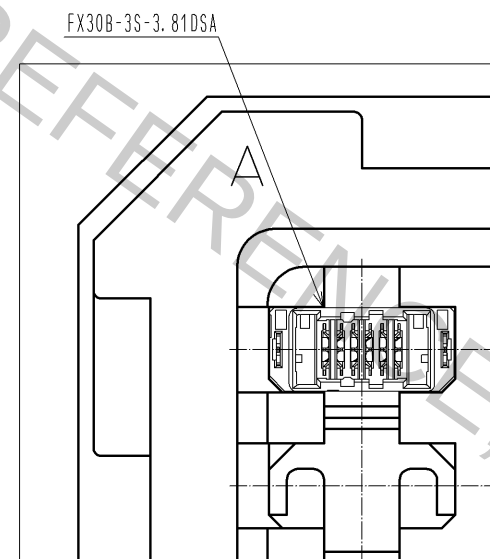
RECOMMENDED HOLE PATTERN DIMENSION OF PCB(5:1)
(CONNECTOR MOUNTING SIDE, PCB THICKNESS: t=1.6mm)



1 DRAWING FOR PACKAGING(1:2)



A(1:1)



HRS

DRAWING NO.	EDC3-347273-00
PART NO.	FX30B-3S-3.81DSA
CODE NO.	CL570-3501-4-00

2/2